Contact electrification,[1–4] also named as triboelectrification, is one of the oldest and most universally-existing phenomena in the nature and people’s daily life, and the study of which can be dated back centuries ago. However, the understanding of its fundamental mechanisms is rather poor and the proposed mechanisms remain highly debated[5–8] so that we do not know how to effectively control the density of the triboelectric surface charges through material or surface modification. In practice, this phenomenon is mostly considered as a negative effect in technological applications, such as the cause of shocks and explosions as safety hazards,[9,10] the damages to the electronic devices and equipment,[11] and the interference to wireless communication. The positive applications of the phenomenon are only in several limited areas, such as laser printing,[12] photocopying,[13] electrostatic separations[14] and driving chemical reactions.[15,16]

In the last three years, this effect has been innovatively used to develop a new energy technology—triboelectric nanogenerators (TENGs)[17–25] that can efficiently convert different types of mechanical energy into electricity, which could not only provide sustainable power sources for small electronics, but also potentially contribute to solve the worldwide energy crisis. The operation mechanism of the TENGs is based on the conjunction of the triboelectrification and the electrostatic induction. Thus, both the voltage and the current outputs of the TENGs are proportional to the triboelectric charge density on the surface,[26,27] so that the output power has a quadratic dependence on the charge density. Therefore, a key approach for the improvement of TENGs’ output performance from the materials aspect is to increase the triboelectric charge density through material optimization and surface functionalization. However, because surface charges will generate the electric field in the surrounding media (such as the air), the achievable charge density will be limited by the breakdown electric field of the air in the proximity region,[4] which will result in a maximum surface charge density (MSCD) that should be mainly determined by the structure of a TENG. So far, either the theoretical value or the influence of the structural parameters on the MSCD are not available, which are, however, critically important for improving the TENGs’ output. Therefore, both theoretical analysis and experimental study of the MSCD are highly desirable.

In triboelectric nanogenerators, the static surface charges are created by the triboelectrification process between the two different surfaces, in which the driving force is possibly related to the difference of the surface chemical potentials, for example.[3,4] Thus, a high triboelectric surface charge density can only come from two surfaces with a large difference in surface potentials, e.g., the fluorinated ethylene propylene (FEP) that is terminated with the most electronegative functional group—fluoro—as the negative side, and the Al—a reactive metal—as the positive side. An intensive transfer of electrons across the interface for the compensation of the surface potential difference will bring the negative charges to the FEP surface after it gets separated from Al (Figure 1a). Although this triboelectrification process is very effective and practical in generating the static surface charges for mechanical energy harvesting, it creates some difficulties for the study of the MSCD for TENGs. First, as limited by the surface potential difference between conventional materials, the triboelectric charge density generally cannot reach an ultimate high level to approach the MSCD. For example, this charge density generated between FEP and Al is often on the level of tens of µC/m², as shown by the experimental results presented below. Also, as determined by the intrinsic property of the two surfaces, the triboelectric charge density cannot be directly controlled or varied without changing the materials employed, which is very inconvenient for the experimental study of the MSCD. More importantly, in the triboelectrification-enabled generator, the generation of surface charges and the conversion of mechanical energy are taking place concurrently, so that it is hard to judge if the measured surface charge density is the result of chemical potential difference between the two materials or being limited by the consequence of air breakdown.

Because a key process in the TENG is electrostatic induction due to the presence of static surface charges, they can be introduced or enhanced by other means in addition to the surface triboelectrification. Here in this paper, a process of injecting single-polarity charged particles/ions onto the surface of an electret[28,29] (referring to the dielectrics that can quasi-permanently preserve the charges for a very long period of time even
for years) is introduced for enhancing the output of TENGs. Through adjusting the injection cycles in this method, the surface charge density can be directly controlled to possibly reach any desired level. Moreover, this method helps to separate the generation of electrostatic surface charges from the mechanical energy conversion process. As a result, the MSCD was studied for the first time for the contact-mode TENG both experimentally and theoretically. Our results show that the MSCD will get larger when the thickness of the dielectric film gets smaller. This relationship serves as an important structural design guidance for the realization of high output TENGs through material/surface modification. On the other hand, this ion-injection method also serves as an effective approach for gigantic elevation of the TENGs’ output power by as much as 25 times, which was proven to be stable over a 5 months and 400 000 continuous operation cycles. Therefore, both the method reported in this paper and the conclusions about the MSCD will open up extensive future materials research for high output TENGs.

The ionized-air-injection for the introduction of the surface charges was achieved by a special tool—an air-ionization gun, which can produce ions of both polarities through trigering the discharge of air inside the gun. The polarity of the ions injected from the gun’s outlet can be manually controlled by either squeezing or releasing of the trigger bar. Actually, the general use of the gun is to remove the electrostatically-attracted dusts through neutralizing the surface charges. In our study, we utilize it to bring the negative charges onto the surface of FEP (which is also an electret material), as shown in Figure 1b. The trigger of the gun was firstly squeezed with the outlet facing away from the FEP surface, during which the positive ions (mainly composed of \((\text{H}_2\text{O})\text{H}^+\)) were injected from the outlet. Subsequently, the gun’s outlet was moved to directly facing the FEP surface with a vertical distance of ~3 cm and then the trigger was gently released. During this, the negative ions \((\text{CO}_3^{−}, \text{NO}_3^{−}, \text{NO}_2^{−}, \text{O}_3^{−} \text{and O}_2^{−})\) were injected onto the surface of FEP, making it negatively charged. The surface charges introduced by this method do not rely on the chemical property of the surface. Through repeating this ion-injection procedure multiple times, the negative charges on the surface can reach a very high level, which could possibly approach the level for the breakdown of the air.

Compared to one of the existing approaches for the introduction of surface charges in previous electret researches—the corona discharging method that needs a high voltage and a complicated set of equipment,[31,32] the ion injection method here is similar in principle but much simpler and more convenient because it only utilizes a hand-sized air-ionization gun. Moreover, it is the first time of using this method to create the surface charges in the recently-invented TENG structures, through which the TENGs’ power output can be largely improved and the MSCD can be systematically studied. In this paper, the vertical contact-mode TENG—one of the 4 fundamental TENG modes—is taken as the primary example for the study.

In the basic structural design of the contact-mode TENG, the dielectric layer (i.e., the FEP film used in this study) is deposited with the electrode on the back. In order to reach a high surface charge density through the as-developed ion-injection method for the TENG, we purposely have the dielectric layer’s back electrode connected to the ground during the injection. In this way, the arrival of the negative ions onto the surface will electrostatically induce the transfer of the same amount of electrons from the bottom electrode to the ground, thus making the bottom electrode positively charged with the same charge density (Figure 2a). As a result, the double-layered opposite charges will confine the electrical field only within the FEP film. Because the FEP’s dielectric strength (~2.6 × 10⁸ V/m) is almost two orders of magnitudes higher than that (3 × 10⁶ V/m) of the air, the charge density on FEP surface from this ion-injection process can reach a much higher level than that on an electrode-free FEP layer in which the achievable charge density will be limited by the...
breakdown electric field of the air. After such an ion-injection process is performed for a few times, the negative surface charges on the FEP will reach a very high density, which equals to the density of the positive charges on the bottom electrode (Figure 2b).

Then, this FEP/electrode double layer will be assembled with an Al layer of the same size in a face-to-face configuration to form a vertical contact-mode TENG, as shown in Figure 2c. A set of four springs will work together with two acrylic supporting substrates to keep the Al plate separated from the FEP layer at the deformation-free condition, with the vertical-to-plane distance much larger than the thickness of the FEP film. The Al plate as the top electrode is connected to the bottom electrode through an external load. When the mechanical motion of surrounding objects provides a pressing force onto the Al plate, it will move towards the FEP surface, which will lower the induced potential on the Al. As a result, the positive charges on the bottom electrode will be driven to transfer onto the Al layer through the external circuitry, generating the electricity in the first half cycle (Figure 2d). When the Al layer gets into fully contact with the FEP surface, all the positive charges should have transferred onto the Al's lower surface, so that they will locate at the same plane with the negative charges on the FEP (Figure 2e). Subsequently, when the pressing force is released, the Al layer will start to get separated from the FEP surface due to the resilience of the springs, creating a potential difference between the two electrodes because of the separation of the

Figure 2. Basic processes of the ion injection on the FEP film and operation principle of the contact-mode TENG built using the FEP film. (a) Injecting negative ions onto the FEP surface from an air-ionization gun. The bottom electrode attached to the FEP film is grounded during this process so that the positive charges can be induced onto the electrode to screen the electrical field from the injected negative charges. (b) When the ion-injection is completed, the FEP surface and its bottom electrode have the opposite charges with the same density. (c-f) The ion-injected FEP/electrode double layer is assembled with an Al layer to form a contact-mode TENG, with 4 springs supported in between to get them separated (not shown in the figures). The electricity generation cycle of this contact-mode TENG under the periodic deformation force is shown in these four schematic diagrams following the count clock rotation as indicated. In each deformation process, the amount of charges transferring through the external load is equal to the amount of the surface charges on the FEP.
opposite charges. The positive charges will then transfer back from the Al layer to the bottom electrode of FEP, producing the second current pulse in the reverse direction (Figure 2f). When the vertical separation distance gets much larger than the thickness of the FEP film, all the positive charges will return back to the bottom electrode and the TENG will revert to the state shown in Figure 2c. Thus, in each deformation process (either pressing or releasing), the amount of charge transferred across the load equals to the amount of the negative charges on the FEP surface.

As mentioned above, through using the ion injection method, the charge density can be manually controlled, and the charge generation process is independent of the electricity generation process. Thus, this method makes it possible to systematically study the MSCD for TENGs. In the charge injection process as shown in Figure 2a, the amount of the negative charges injected onto the FEP surface can be instantaneously monitored by using a coulomb meter to measure the charge flow from the ground to the bottom electrode (inset of Figure 3a). As shown in Figure 3a, each time of ion injection will cause a transfer of charges with an area density of ∼40 µC/m² from the ground to the bottom electrode, implying the charges of the same density being introduced onto the FEP surface. When the ion injection was repeated for multiple times, the negative charges injected onto the FEP surface accumulated step by step. In the consecutive 17 times of injection, the negative charges on the FEP surface continued to increase on the FEP surface. This would result in the loss of the surface charges in the first cycle of deformation after the ion injection.

Such a step-by-step ion injection for the enhancement of the surface charge density has also been studied in a TENG structure. Each time after one ion injection step, the FEP/electrode double layer is assembled with an Al plate into a contact-mode TENG. Then the short-circuit charge density (∆σ_{SC}) generated by the TENG was measured, which should be equal to the surface charge density (σ₀) on the FEP film. In this set of experiments, the thickness of the utilized FEP film is 50 µm. At first, the output of the TENG was tested before the FEP film was injected with negative ions, in which the static surface charges were fully generated by the triboelectrification with Al. As shown in Figure 3b, in this initial group, the TENG only produced a ∆σ_{SC} of ∼50 µC/m², which stands for the triboelectric surface charge density on the FEP surface. Subsequently, the ion injection led to the elevation of the ∆σ_{SC} step by step. It should be noted that for the effective accumulation of the negative charges on the FEP surface it is very important to connect the FEP’s bottom electrode to the ground in each ion injection step. If failed to do so, the ion injection could not effectively enhance the ∆σ_{SC} (i.e. the σ₀) of the TENG (Figure S1). As shown in Figure 3b, after the first few times of injection, the ∆σ_{SC} approached the level around 240 µC/m². Subsequently, every time of injection will only lead to a small increase on ∆σ_{SC}. After the 9th time of injection, the charge transfer behavior suddenly became distinctively different, as marked by the red box in Figure 3b. The first pressing motion after the additional cycle of ion-injection led to a charge transfer with a density of ∼260 µC/m². Then, when the Al layer was released to get separated from the FEP layer, the reverse charge transfer only had an amount of ∼230 µC/m², so that the ∆σ_{SC} curve could not return to the base line after the first full deformation cycle. In the following cycles, the ∆σ_{SC} stayed at the level of 230 µC/m². Since the amount of charge flow in each deformation process equals to the amount of the surface charges on FEP, this abrupt decrease of ∆σ_{SC} should come from the loss of the static surface charges as a result of air breakdown during the first releasing process, which is triggered by a voltage drop across the air gap between the Al layer and the FEP surface during the separation process (Figure 3c). The existence of this voltage drop can be verified by the numerical simulation of the potential distribution in this TENG system at the short-circuit condition. As shown in the bottom image of Figure 3c, when the gap distance is half the thickness of the FEP (set as 50 µm in the simulation model), a voltage drop (V_{gap}) of ∼300 V exists across the air gap, which is proportional to the σ₀ on the FEP. So if a σ₀ leads to a V_{gap} higher than the threshold voltage for the air breakdown at a certain gap distance, the positive ions from the air discharging corona will partially screen the negative charges on the FEP surface. This would result in the loss of the surface charges in the first cycle of deformation after the ion injection.

With the help of this ion injection method, this unique charge transfer behavior in the last group of operation in Figure 3b can serve as an indication of the air breakdown during the operation of the TENG, in which the initial short-circuit charge density (∆σ_{SC-I}) from the first pressing deformation is evidently larger than the charge density (∆σ_{SC-R}) in the remaining deformation cycles thereafter, as shown in such a magnified charge transfer curve in the inset of Figure 3d. This provides an effective way to study the MSCD for a TENG structure. Through changing the times of ion injection, we introduced widely-varied surface charge densities onto the FEP layer. After each set of ion injections, the FEP film was assembled into the TENG to test the charge transfer behavior, from which the ∆σ_{SC-I} and ∆σ_{SC-R} can be obtained and then plotted in the same figure with the ∆σ_{SC-I} value as the horizontal axis and the ∆σ_{SC-R} as the vertical axis. As shown in Figure 3d, in the Region I where ∆σ_{SC-I} is within the relatively small range, the plotted points almost stay on the line of ∆σ_{SC-I} = ∆σ_{SC-R}. This is the normal charge transfer behavior we observed from the TENG in which there is no air breakdown happening. Then, when the ∆σ_{SC-I} is further increased to a range over 200 µC/m², the points start to deviate downward from the above line, and the surface charge density starts to get into Region II in which the air breakdown is induced. In this region, a higher ∆σ_{SC-I} leads to a smaller ∆σ_{SC-R}. The possible reason is that when the surface charge density on the FEP exceeds the maximum charge density by a larger extend, the discharging of the air will be more intensive, which could probably cause a stronger screening to the negative surface charges on the FEP. From this plot, the MSCD can be easily obtained either from the border between the two regions, or from the highest achievable value of the ∆σ_{SC-R}. Thus, the σ_{max} for this TENG structure with the FEP thickness of 50 µm is ∼240 µC/m².
The MSCD for the contact-mode TENG can also be obtained from the theoretical analysis by comparing the threshold voltage for the air breakdown and the actual voltage drop ($V_{\text{gap}}$) across the air gap in the contact-mode TENG. From the theoretical derivation (shown in the Supporting Information), the $V_{\text{gap}}$ has the following relationship with the gap distance ($x$):

$$V_{\text{gap}} = \frac{\varepsilon_0 E_x}{2} x$$

where $\varepsilon_0$ is the permittivity of free space and $E_x$ is the electric field strength.

Figure 3. Step-by-step measurement of the ion-injection process and study of the maximum surface charge density for the TENG. (a) In-situ measurement of the charge flow from the ground to the bottom electrode of the FEP film during the step-by-step ion injection process. (b) Elevation of the short-circuit charge density ($\Delta \sigma_{\text{SC}}$) generated by the TENG when the FEP film was injected with ions time-by-time. (c) Schematic and numerical simulation results showing the voltage drop ($V_{\text{gap}}$) in the air gap between the Al and the FEP layers, which could cause the breakdown of the air. (d) Plot showing the relationship between the initial short-circuit charge density ($\Delta \sigma_{\text{SC-I}}$) from the first pressing motion of the TENG right after the ion-injection process on the FEP film, and the short-circuit charge density ($\Delta \sigma_{\text{SC-R}}$) in the remaining cycles. The inset is the magnified curve for the short-circuit charge density when the air-breakdown happens in the first deformation cycle so that $\Delta \sigma_{\text{SC-R}}$ is smaller than $\Delta \sigma_{\text{SC-I}}$. (e) Plots of the air-breakdown voltage and the voltage drop ($V_{\text{gap}}$) across the gap in the TENG system, with the relationships to the gap distance ($x$). (f) Theoretical relationship between the maximum surface charge density ($\sigma_{\text{max}}$) and the thickness ($d$) of the FEP film. (g) Plot of the above theoretical relationship in the range of 20-150 µm, with the three points of the experimentally obtained $\sigma_{\text{max}}$ for the $d$ of 50, 75 and 125 µm, respectively.
\[ V_{\text{pp}} = \frac{d \sigma_{\text{r}} x}{\varepsilon_0 (d + xe_\varepsilon)} \]  

(1)

where \( d \) is the thickness of the FEP film, \( e_\varepsilon \) is the relative permittivity of the FEP layer, and \( \varepsilon_0 \) is the vacuum permittivity. This relationship between the \( V_{\text{pp}} \) and the \( x \) can be plotted under different \( \sigma_0 \) and \( d \), as shown in Figure 3e (the blue, green, orange and purple curves). It can be found that both a higher \( \sigma_0 \) and a higher \( d \) will bring a larger \( V_{\text{pp}} \).

For the breakdown voltage of a gas between two plates at a small gap distance, it follows the Paschen curve—an empirical law showing the relationship of the breakdown voltage and the gap distance,[35,36]

\[ V_{\text{e-b}} = \frac{A(P_x)}{\ln(P_x) + B} \]  

(2)

where \( P \) is the pressure of the gas, \( A \) and \( B \) are the constants determined by the composition and the pressure of the gas. For air at standard atmospheric pressure of 101 kPa (i.e. the usual surrounding condition of a TENG), \( A = 2.87 \times 10^2 \) V/(atm·m), and \( B = 12.6[-8] \). The curve for the air breakdown threshold is also plotted in Figure 3e (the red curve). It can be found that the minimum value of the threshold voltage is reached at a certain gap distance.

Thus, when \( x \) starts to increase from 0 during the releasing half cycle of the TENG, the \( V_{\text{gap}} \) needs to remain smaller than \( V_{\text{e-b}} \) at any \( x > 0 \) in order to avoid breakdown of air, which also means that the \( V_{\text{gap}} \) curve is required to stay below the air breakdown curve shown in Figure 3e. So the following relationship should be satisfied for any \( x > 0 \):

\[ \frac{A(P_x)}{\ln(P_x) + B} - \frac{d \sigma_{\text{r}} x}{\varepsilon_0 (d + xe_\varepsilon)} > 0 \]  

(3)

From this, the MSCD (\( \sigma_{\text{max}} \)) for a TENG with the dielectric thickness of \( d \) is:

\[ \sigma_{\text{max}} = \left( \frac{AP_\varepsilon (d + xe_\varepsilon)}{d \ln(P_x + B)} \right) \text{min} \]  

(4)

From this equation, with \( d = 50 \) µm (the same as this experimentally studied case), the theoretical \( \sigma_{\text{max}} \) is numerically calculated to be 241.05 µC/m², which matches very well with the above experimentally obtained value of ~240 µC/m². As shown in Figure 3e, when \( d = 50 \) µm and \( \sigma_0 = 240 \) µC/m², the \( V_{\text{gap}} \) curve (blue) is in tangential contact with the air breakdown voltage curve, reflecting the threshold condition.

Moreover, the Equation (4) also clearly reveals the influence of the TENG’s structural parameter—the thickness (\( d \)) of the dielectric film—on the \( \sigma_{\text{max}} \). Through numerically plotting the curve of \( \sigma_{\text{max}} \) vs. \( d \) according to this equation, we can find that the \( \sigma_{\text{max}} \) will get larger at a smaller film thickness, as shown in Figure 3f. With the \( d \) reduced from the range of tens of microns to hundreds of nanometers, the \( \sigma_{\text{max}} \) will increase by 2 orders of magnitude to go beyond 10 mC/m². Such a theoretical relationship between the \( \sigma_{\text{max}} \) and the \( d \) can be verified by experiments. We further carried out 2 similar sets of experiments on the FEP films with the thicknesses of 75 µm and 125 µm, respectively, to determine the corresponding \( \sigma_{\text{max}} \) for them with the help of the ion-injection method. The \( \Delta \sigma_{\text{SC-I}}-\Delta \sigma_{\text{SC-R}} \) plots for these two film thicknesses are shown in Figure S2, from which the \( \sigma_{\text{max}} \) values can be obtained. Then the three points representing the \( \sigma_{\text{max}} \) for these \( d \) values were plotted together with the theoretical \( \sigma_{\text{max}} \sim d \) curve within the range of 20–150 µm in Figure 3g. It can be found that the experimental points have a very good overlapping with the theoretical curve. Thus, this influencing behavior of the film thickness on the MSCD has been illustrated both theoretically and experimentally, which clearly indicates that a thinner dielectric film is favorable for building a high-output TENG through the improvement of the surface charge density.

We also experimentally studied the effectiveness of this ion injection method for the improvement of the surface charge density in the other two fundamental modes of TENGs—the sliding mode[19,20] and the single-electrode mode.[23] As for the sliding mode, the \( \Delta \sigma_{\text{SC}} \) from the 50-µm-FEP-based sliding-TENG has been improved by over one time through the injection of the negative ions (Figure S3), which reflects the improvement on the surface charge density (\( \sigma_0 \)). However, it can be noticed that the \( \sigma_{\text{max}} \) of this sliding-TENG is much smaller than that of the contact-mode TENG with the same film thickness (\( d \)). This should result from a different distribution and strength of the electric field at the separating edge in the sliding-TENG. For the single-electrode mode TENG, in which the dielectric film doesn’t have an electrode layer attached at the back, the ion injection method cannot effectively improve the surface charge density, as shown in Figure S4. This is because that with the absence of the back electrode, there is no oppositely charged layer to screen the electric field generated by the negative charges on the FEP, so that the air breakdown can be initiated at a large charge density. Thus, it implies that compared to the single-electrode TENGs in which the surface charge density can only stay at a low range, the contact-mode and the sliding-mode are favorable for realizing a high power output.

This ion injection method for the introduction of the surface charges can largely enhance the power output of the TENG for mechanical energy harvesting, through effectively increasing the surface charge density on the FEP. From the measured \( \Delta \sigma_{\text{SC}} \) of the TENG before and after the ion injections as shown in Figure 3b, a five-fold enhancement of the surface charge density (also the \( \Delta \sigma_{\text{SC}} \)) is achieved by this ion injection method, which should lead to a proportional increase of both the open-circuit voltage (\( V_{\text{OC}} \)) and the short-circuit current density (\( J_{\text{SC}} \)). As shown in Figure 4a, before the ion injection, the TENG can only produce a \( V_{\text{OC}} \) of ~200 V. After the ion injection from which the surface charge density was increased to the maximum value (240 µC/m²), the \( V_{\text{OC}} \) from the TENG was increased to ~1000 V (Figure 4b). As for the \( J_{\text{SC}} \), before and after the ion injection both generated by gentle hand pressing (with an approximate pressing force of 20 N), it increased from ~18 mA/m² to ~78 mA/m² (Figure 4c&d). If this ion-injection-enhanced TENG was triggered by a much higher pressing force that leads to a much faster deformation process, the generated \( J_{\text{SC}} \) could reach a very large magnitude. As shown in Figure 4e, under the pressing force of ~300 N, the TENG generated a \( J_{\text{SC}} \) as high as 900 mA/m². It should be noted that the varied magnitudes of the \( J_{\text{SC}} \) peaks come from the variation of the
The power output density of this TENG reached the maximum value of $\sim 315 \text{ W/m}^2$ at the resistance of $300 \Omega$. Therefore, the ion-injection is a very effective method for the improvement of TENGs' power output. Considering that the MSCD becomes larger when the film thickness gets smaller, the power output of the TENG can possibly be enhanced to a

**Figure 4.** Enhancement of the TENG’s output performance by the ion injection method. (a-b) Open-circuit voltages of the TENG: (a) before any ion injection process, in which the surface charges are only generated by the triboelectrification; (b) after the ion-injection process that increased the surface charge density on the FEP to the maximum value. (c-d) Short-circuit current densities of the TENG under the gentle pressing of hand with the force of $\sim 20 \text{ N}$: (c) before any ion injection process; (d) after the ion-injection process that increased the surface charge density on the FEP to the maximum value. (e) Short-circuit current density of the TENG after the ion injection, under the deformation force of $\sim 300 \text{ N}$. (f) With the above TENG after the ion-injection connected to the loads with different resistances, the current density and the voltage on the loads. (g) Power density obtained by the loads with different resistances.

dynamic deformation rates of the TENG. Under this deformation condition, the actual power output from this ion-injection-enhanced TENG was tested by connecting the TENG to a series of loads with different resistances. As shown in Figure 4f, the current density through the load gradually decreases with the increase of the resistance, while the voltage follows a reverse trend. The power output density of this TENG reached the maximum value of $\sim 315 \text{ W/m}^2$ at the resistance of $300 \Omega$. Therefore, the ion-injection is a very effective method for the improvement of TENGs’ power output. Considering that the MSCD becomes larger when the film thickness gets smaller, the power output of the TENG can possibly be enhanced to a
much higher level by the ion-injection method if a thinner FEP film is used. When the TENG is constructed by an electret film (e.g., the FEP in this demonstration), the surface charges brought by the ion-injection method can be preserved for as long as years, so that the TENG can deliver an elevated output for a long term after its dielectric surface gets pre-charged. In order to study the stability of the surface charge on the FEP, we regularly measured the $\Delta \sigma_{SC}$ from the TENG constructed using this FEP film in a time range of 160 days. From the results in Figure 5a, the $\Delta \sigma_{SC}$ only decayed from the initial value of $240 \, \mu C/m^2$ that was measured right after the ion injection, to $\sim 200 \, \mu C/m^2$ after 80 days, and then almost got stabilized at this value. Thus, there is only $\sim 16.6\%$ loss of the surface charges, and the remained $\Delta \sigma_{SC}$ after 160 days is still 3 times higher than the $\Delta \sigma_{SC}$ generated by the TENG without the ion injection process. Moreover, even when the ion-injection-charged FEP surface is kept in the intimate contact with the Al film for an extended period of time, the negative charges can still stably exist, with the experimental data shown in Figure S5. Thus, under the continuous operation during which the FEP surface and the Al get into contact from time to time, the largely elevated output of this TENG should still have a good stability. As shown in Figure 5b, when the contact-mode TENG was periodically triggered by the external pressing force, the generated $\Delta \sigma_{SC}$ only has a little decay in the continuous operation of $\sim 400,000$ cycles. Therefore, both of the above two groups of measurements clearly show that the ion injection method is an effective and practical method for building the TENG that can deliver a largely-enhanced output for a sufficiently long time.

Because the air-ionization gun can generate and inject both positive and negative ions in a selective manner, this ion injection method demonstrated in this work could possibly get the triboelectrically-negative FEP film positively charged. As shown in Figure S6, 10 repeated times of positive ion injection converted the negatively-charged FEP surface with a density of $\sim 240 \, \mu C/m^2$ to the state of carrying $+200 \, \mu C/m^2$ positive charges. However, it has been observed that the stability of the positive charges on the FEP surface is much worse than the negative charges (from the comparison of Figure 5a and Figure S8). Thus, the electret material can only stably preserve the charges with the same polarity of the material itself. Moreover, the ion injection method can also significantly enhance the surface charge density on non-dielectric materials (e.g., Kapton) and thus improve the power output of the constructed TENGs, as shown in Figure S6. It can be noticed that the $\sigma_{max}$ of the Kapton film with the same thickness (50 µm) is a bit higher than the $\sigma_{max}$ of the FEP layer. This is because Kapton’s relative permittivity ($\varepsilon_r = 3.4$) is larger than that ($\varepsilon_r = 2.1$) of FEP. As expected, the injected charges on the non-electret Kapton film showed a much faster decay than the charges on the electret film (Figure S9).

The relationship between the TENGs’ maximum surface charge density and the thickness of the dielectric film unraveled in this paper clearly shows the possibility of improving the triboelectric charge density in TENGs by as much as 2 orders of magnitude! This could be achieved through the research efforts in the following directions. First, in-depth studies on the fundamental mechanism of the contact electrification process using advanced technologies and tools (such as atomic force microscopy$^{[6,37,38]}$) can help us to gain better insights about the driving force for the charge transfer during the contact electrification. Second, the development of chemical approaches to modify the material and/or functionalize the surface will realize the increase of the driving force for the triboelectrification: either by creating two triboelectric surfaces densely covered with the highly polarized functional groups respectively (e.g., -F, -Cl as the negative functional groups and -NH$_2$, amide, pyridine as the positive groups)$^{[39]}$ or even by synthesizing new functional groups with higher polarities. Moreover, according to deepened understanding of the contact-electrification, introducing the optimized nano-/micro-structures on the surface could also help to increase the obtained surface charge density. Thus, the discoveries in this paper open up a huge research opportunity in the field of triboelectric nanogenerators for the chemists and material scientists.

In summary, the ion injection method for the introduction of surface charges demonstrated in this paper has helped us to make three marked progresses along the research track of the improvement to the triboelectric nanogenerators’ power output. Firstly, this method provides a simple but effective approach for the enhancement of the TENG’s output, through which a 25-fold enhancement and a maximum power density of $\sim 315 \, W/m^2$ have been achieved in the contact-mode. By using an electret material, the enhanced power output can stably exist at least for months. Secondly, with the help of this method, the existence of the maximum surface charge density for the TENGs due the limitation of the air breakdown was observed and confirmed for the first time. Thirdly, and the
most importantly, we unraveled the direct relationship between the maximum surface charge density and the thickness of the dielectric film in the TENG, both experimentally and theoretically, which not only tells us that thinner dielectric films as the triboelectric layers are favorable for achieving higher surface charge density, but also clearly shows the huge room for future improvement of the TENGs’ power output. By reducing the film thickness to the range of hundreds nanometers, the surface charge density could be 2 orders of magnitudes higher than the current level, which indicates a 4-order of improvement on the TENGs’ output power! This will create a huge drive for the material and chemistry research for improving the surface charge density obtained from triboelectrification processes. Through these studies, not only the TENG-based mechanical energy harvesting will be promoted to technologies and products that reach people’s daily life, but also the development of the surface chemistry and the fundamental understandings of contact electrification will be largely propelled.

Supporting Information
Supporting Information is available from the Wiley Online Library or from the author.

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